Applicant: Loher et al. Application No. 08/849,746:

finished, and said blank is brought into a final form of a component in a negative mold, under pressure, in a hot-forming process, comprising the steps of:

heating the entire blank to a forming temperature with plastic flow consistency in a heating stage located outside the negative mold,

pressing said heated blank into the negative mold, and

shaping the blank in the negative mold by virtue of the entire blank flowing from the heating stage into and filling up the negative mold.

2. FOUR TIMES AMENDED (Clean copy. A marked-up version is also attached.)
A process for manufacturing components which are under stress, made of fiberreinforced thermoplastic materials, where a blank formed with a fiber proportion of
more than 50 volume-% and with at least predominant use of endless fibers and said
fiber-reinforced thermoplastic material is first pre-finished, and said blank is brought
into a final form of a component in a negative mold, under pressure, in a hot-forming
process, comprising the steps of:

heating the entire blank to a forming temperature with plastic flow consistency in a heating stage located outside the negative mold,

pressing said heated blank into the negative mold, and

Applicant: Loher et al. Application No. 08/849,746:

G

shaping the blank in the negative mold by virtue of the entire blank flowing from the heating stage into and filling up the negative mold.

2

7. FOUR TIMES AMENDED (Clean copy. A marked-up version is also attached.)
The process according to Claim 1, wherein the shaping of the blank is accomplished by a reciprocating extrusion-pressing process.

Add the following new claim 27

63

-- 27. The process according to Claim 7, wherein the reciprocating process is performed several times. --

REMARKS

Continued examination of this application is hereby requested in light of the amendments presented herein and the discussion which follows.

Before proceeding, Applicants wish to express appreciation for the Examiner's grant of a telephone interview with Applicants' undersigned representative at which this application was discussed.

Briefly, during this interview, there were proposed amendments to the claims which correspond to those amendments which are presented herein, and arguments in